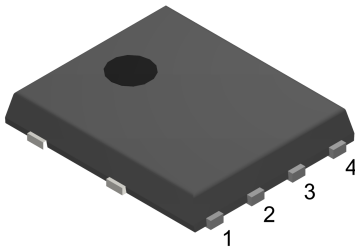
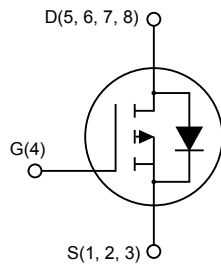


P-channel -60 V, 23 mΩ typ., -42 A STripFET F6 Power MOSFET in a PowerFLAT 5x6 package



PowerFLAT™ 5x6



AM01475v4


Product status

STL42P6LLF6

Product summary

Order code	STL42P6LLF6
Marking	42P6LLF6
Package	PowerFLAT 5x6
Packing	Tape and reel

Features

Order code	V _{DS}	R _{DS(on)} max	I _D
STL42P6LLF6	-60 V	26 mΩ	-42 A

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

- Switching applications

Description

This device is a P-channel Power MOSFET developed using the STripFET F6 technology, with a new trench gate structure. The resulting Power MOSFET exhibits very low R_{DS(on)} in all packages.

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	-60	V
V_{GS}	Gate-source voltage	± 20	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$	-42	A
$I_D^{(1)}$	Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$	-30	A
$I_D^{(1)(3)}$	Drain current (pulsed)	-168	A
$I_D^{(2)}$	Drain current (continuous) at $T_{pcb} = 25\text{ }^\circ\text{C}$	-9	A
$I_D^{(2)}$	Drain current (continuous) at $T_{pcb} = 100\text{ }^\circ\text{C}$	-6.6	A
$I_{DM}^{(3)(2)}$	Drain current (pulsed)	-36	A
$P_{TOT}^{(1)}$	Total power dissipation at $T_C = 25\text{ }^\circ\text{C}$	100	W
$P_{TOT}^{(2)}$	Total power dissipation at $T_{pcb} = 25\text{ }^\circ\text{C}$	4.8	W
T_{stg}	Storage temperature range	-55 to 175	$^\circ\text{C}$
T_j	Operating junction temperature range		

1. The value is rated by $R_{thj-case}$.
2. The value is rated by $R_{thj-pcb}$.
3. Pulse width is limited by safe operating area.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	1.5	$^\circ\text{C/W}$
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb	31.3	$^\circ\text{C/W}$

1. When mounted on FR-4 board of 1 inch², 2 Oz Cu, $t < 10\text{ s}$.

2 Electrical characteristics

($T_C = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Table 3. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$, $I_D = -250\text{ }\mu\text{A}$	-60			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$, $V_{DS} = -60\text{ V}$			-1	μA
		$V_{GS} = 0\text{ V}$, $V_{DS} = -60\text{ V}$, $T_C = 125\text{ }^\circ\text{C}^{(1)}$			-10	μA
I_{GSS}	Gate-body leakage current	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 20\text{ V}$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = -250\text{ }\mu\text{A}$	-1		-2.5	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = -10\text{ V}$, $I_D = -4.5\text{ A}$		23	26	m Ω
		$V_{GS} = -4.5\text{ V}$, $I_D = -4.5\text{ A}$		28	34	

1. Defined by design, not subject to production testing

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = -25\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0\text{ V}$	-	3780	-	pF
C_{oss}	Output capacitance		-	262	-	pF
C_{rss}	Reverse transfer capacitance		-	170	-	pF
Q_g	Total gate charge	$V_{DD} = -30\text{ V}$, $I_D = -9\text{ A}$, $V_{GS} = -4.5\text{ V}$ (see Figure 13. Gate charge test circuit)	-	30	-	nC
Q_{gs}	Gate-source charge		-	10.8	-	nC
Q_{gd}	Gate-drain charge		-	10.5	-	nC
R_G	Gate input resistance	$I_D = 0\text{ A}$, $f = 1\text{ MHz}$	-	1.7	-	Ω

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = -30\text{ V}$, $I_D = -4.5\text{ A}$, $R_G = 4.7\text{ }\Omega$, $V_{GS} = -10\text{ V}$ (see Figure 12. Switching times test circuit for resistive load)	-	51.4	-	ns
t_r	Rise time		-	39	-	ns
$t_{d(off)}$	Turn-off-delay time		-	171	-	ns
t_f	Fall time		-	21	-	ns

Table 6. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-	-42		A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-	-168		A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0\text{ V}$, $I_{SD} = -9\text{ A}$	-		-1.1	V
t_{rr}	Reverse recovery time	$I_{SD} = -9\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$, $V_{DD} = -4.8\text{ V}$, $T_J = 150\text{ }^\circ\text{C}$ (see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	34		ns
Q_{rr}	Reverse recovery charge		-	48		nC
I_{RRM}	Reverse recovery current		-	-2.8		A

1. Pulse width limited by safe operating area
2. Pulse test: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Note: For the P-channel Power MOSFET, current polarity of voltages and current have to be reversed.

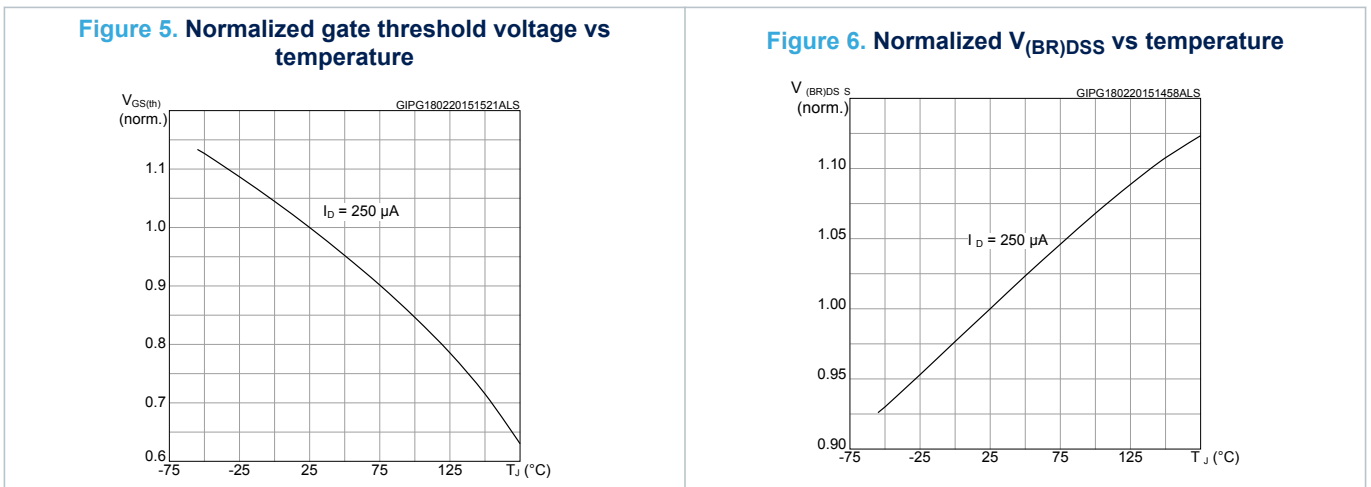
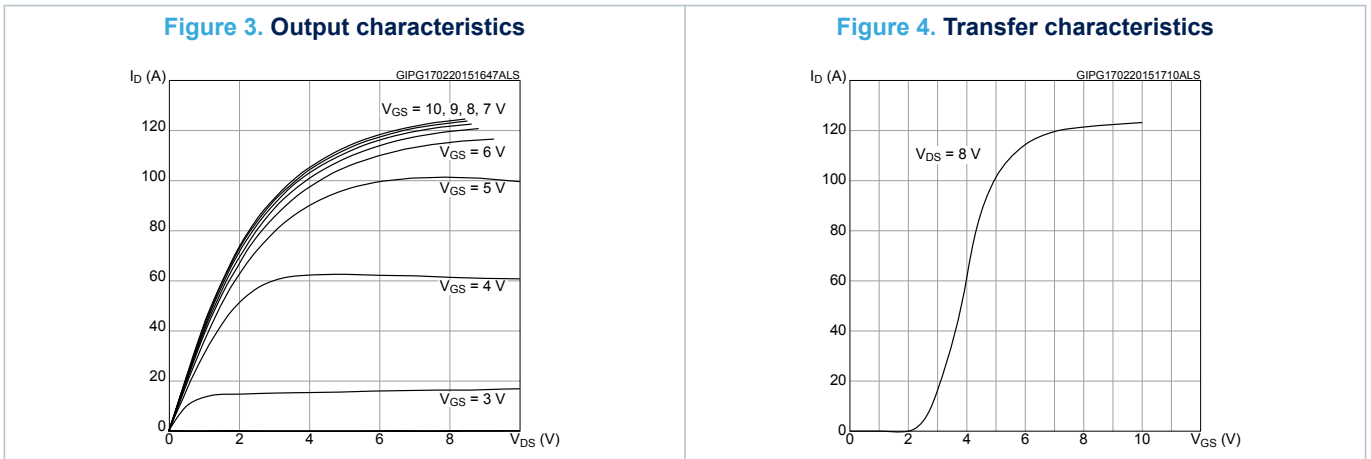
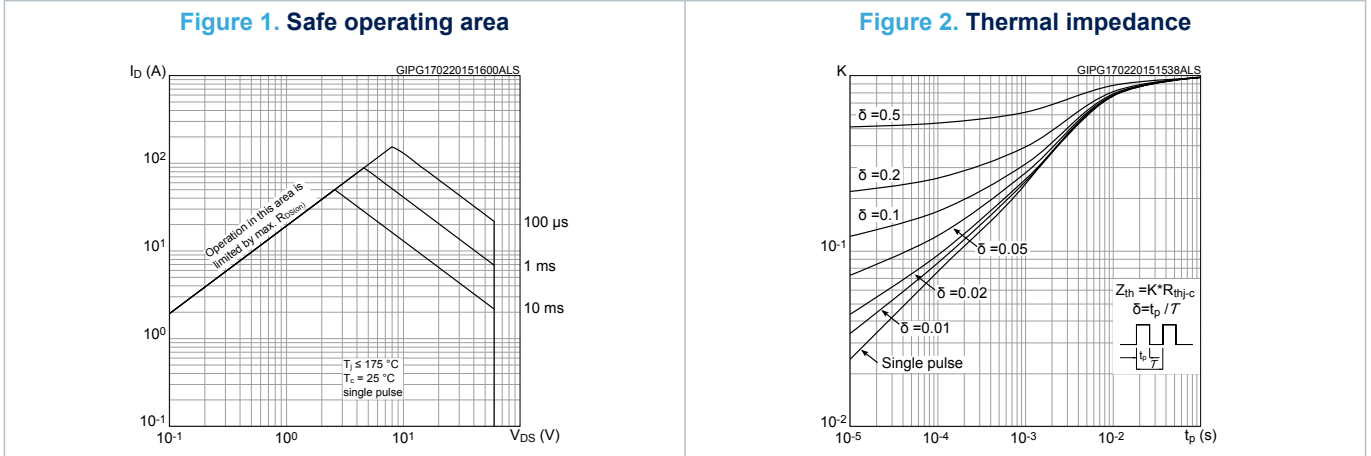


Figure 7. Static drain-source on-resistance

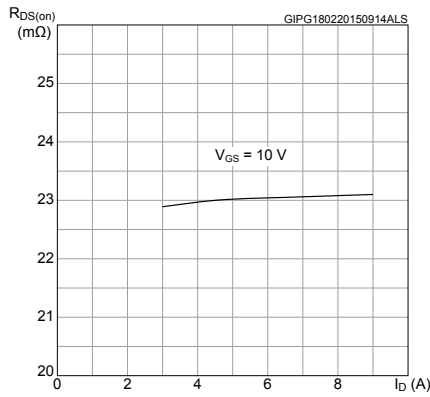


Figure 8. Normalized on-resistance vs. temperature

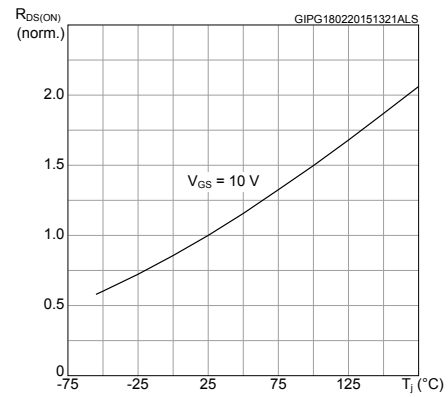


Figure 9. Gate charge vs gate-source voltage

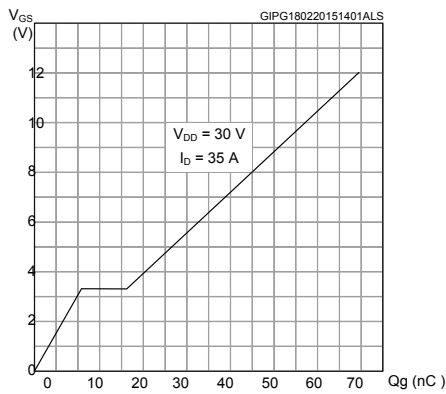


Figure 10. Capacitance variations voltage

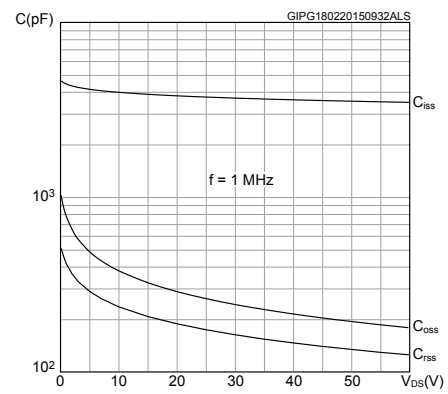
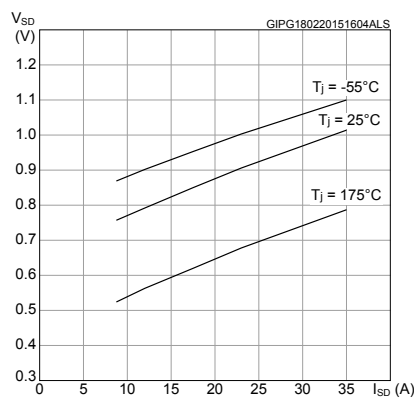


Figure 11. Source-drain diode forward characteristics



3 Test circuits

Figure 12. Switching times test circuit for resistive load

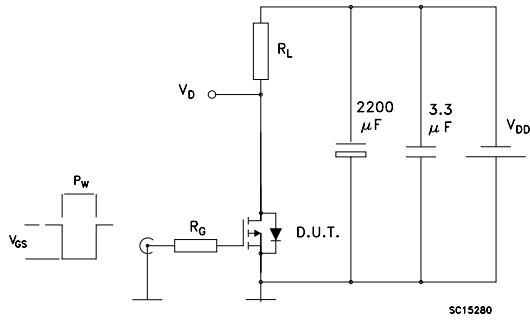


Figure 13. Gate charge test circuit

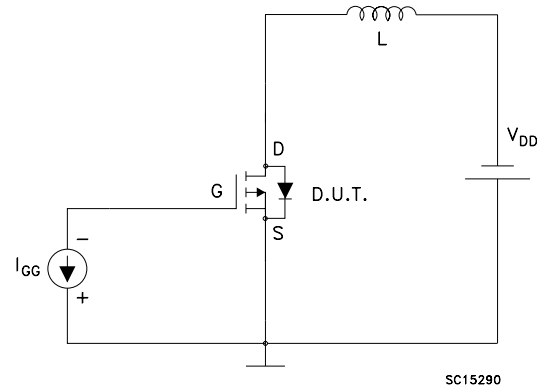
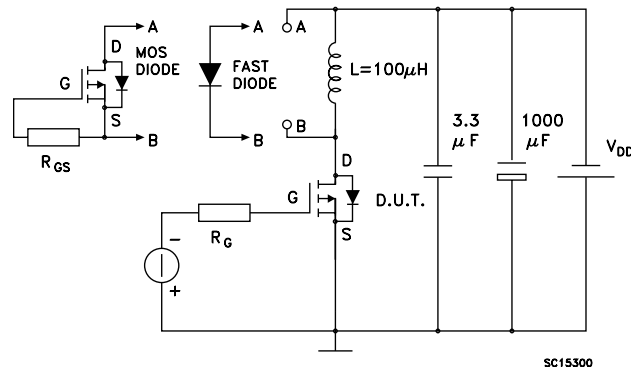


Figure 14. Test circuit for inductive load switching and diode recovery times

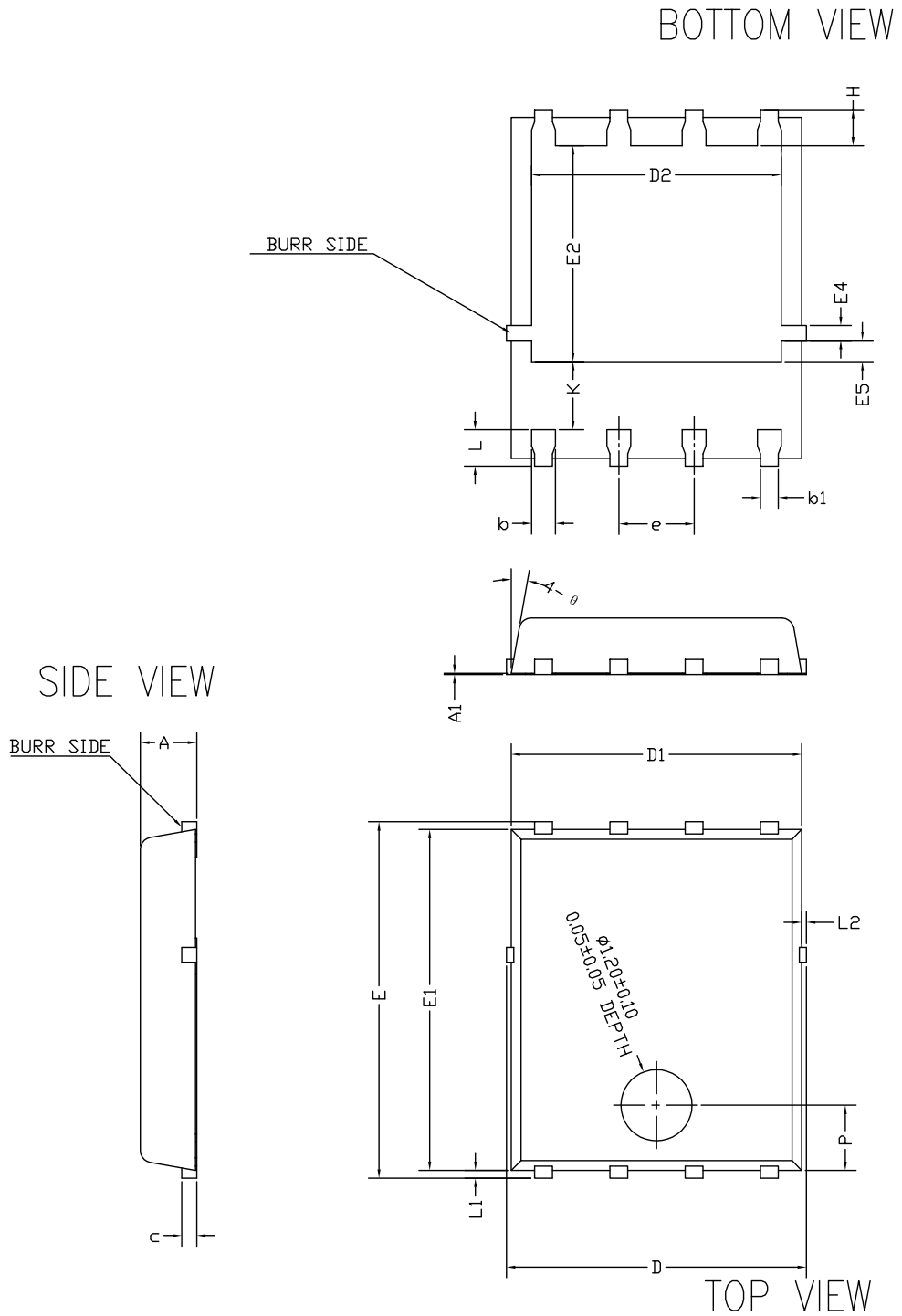


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 PowerFLAT 5x6 type C SUBCON package information

Figure 15. PowerFLAT 5x6 type C SUBCON package outline



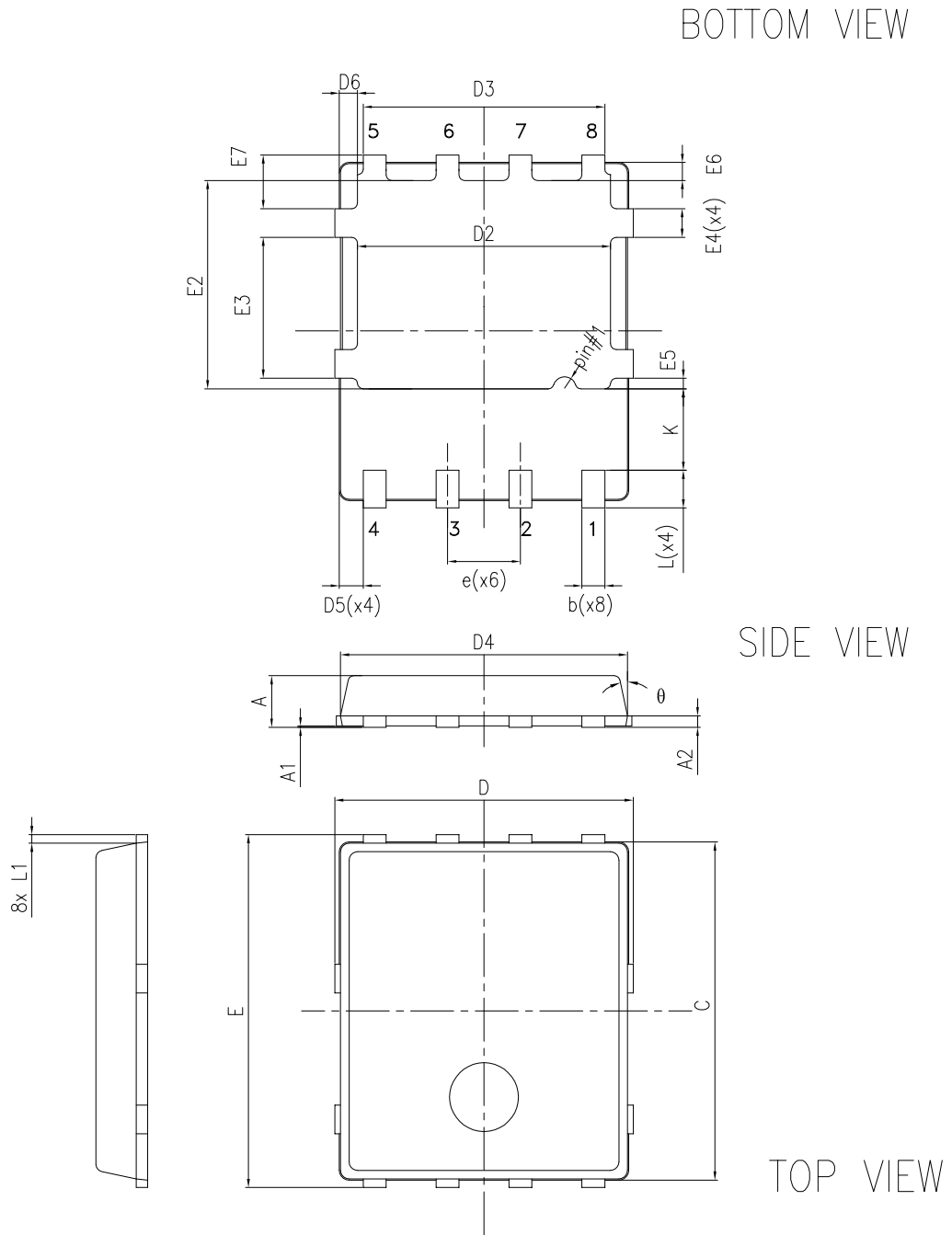
8472137_SUBCON_998G_REV4

Table 7. PowerFLAT 5x6 type C SUBCON package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.90	0.95	1.00
A1		0.02	
b	0.35	0.40	0.45
b1		0.30	
c	0.21	0.25	0.34
D			5.10
D1	4.80	4.90	5.00
D2	4.01	4.21	4.31
e	1.17	1.27	1.37
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.54	3.64	3.74
E4	0.15	0.25	0.35
E5	0.26	0.36	0.46
H	0.51	0.61	0.71
K	0.95		
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
L2			0.10
P	1.00	1.10	1.20
θ	8°	10°	12°

4.2 PowerFLAT 5x6 type R package information

Figure 16. PowerFLAT 5x6 type R package outline

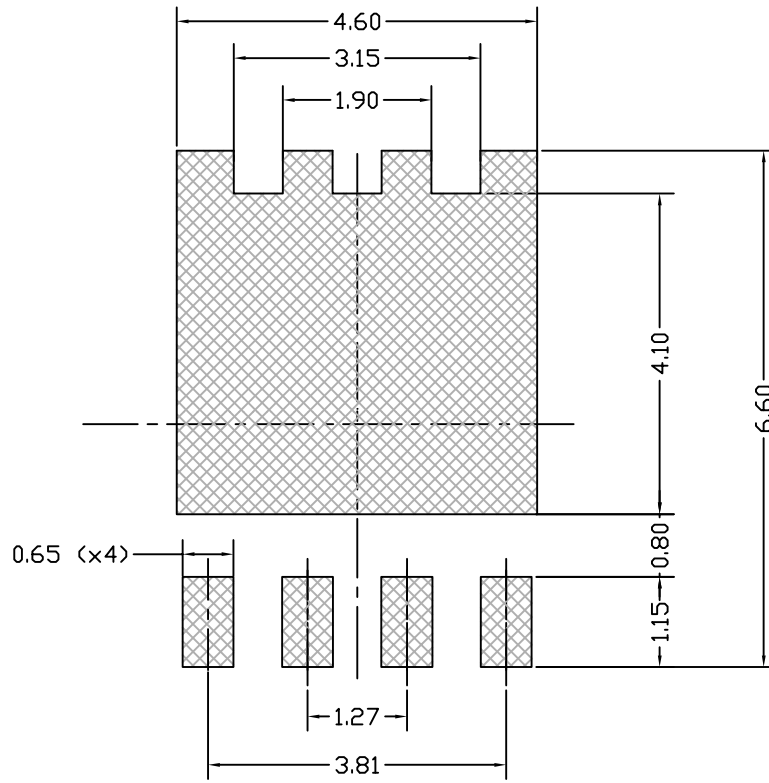


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Table 8. PowerFLAT 5x6 type R mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
C	5.80	6.00	6.20
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.20
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
e		1.27	
E	5.95	6.15	6.35
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.75	0.90	1.05
K	1.275		1.575
L	0.60		0.80
L1	0.05	0.15	0.25
θ	0°		12°

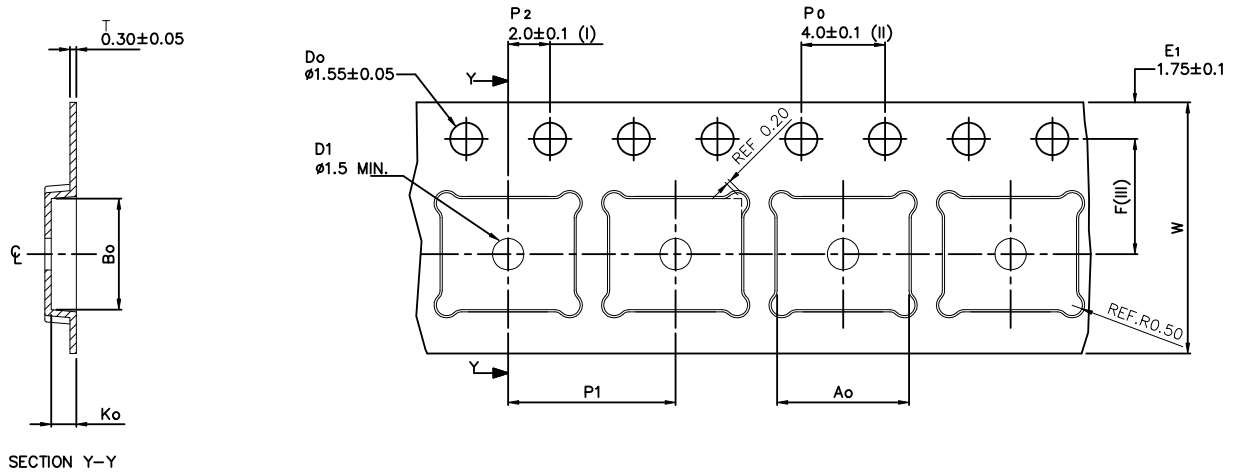
Figure 17. PowerFLAT 5x6 recommended footprint (dimensions are in mm)



8231817_FOOTPRINT_simp_Rev_18

4.3 PowerFLAT 5x6 packing information

Figure 18. PowerFLAT 5x6 tape (dimensions are in mm)



Ao	6.30 +/- 0.1
Bo	5.30 +/- 0.1
Ko	1.20 +/- 0.1
F	5.50 +/- 0.1
P1	8.00 +/- 0.1
W	12.00 +/- 0.3

(I) Measured from centreline of sprocket hole to centreline of pocket.

(II) Cumulative tolerance of 10 sprocket holes is ± 0.20 .

(III) Measured from centreline of sprocket hole to centreline of pocket

Base and bulk quantity 3000 pcs
All dimensions are in millimeters

8234350_Tape_rev_C

Figure 19. PowerFLAT 5x6 package orientation in carrier tape

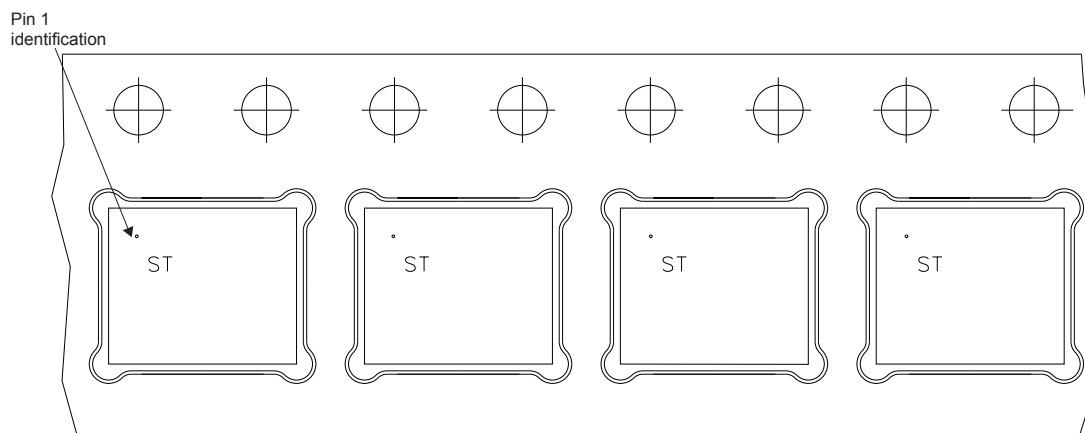
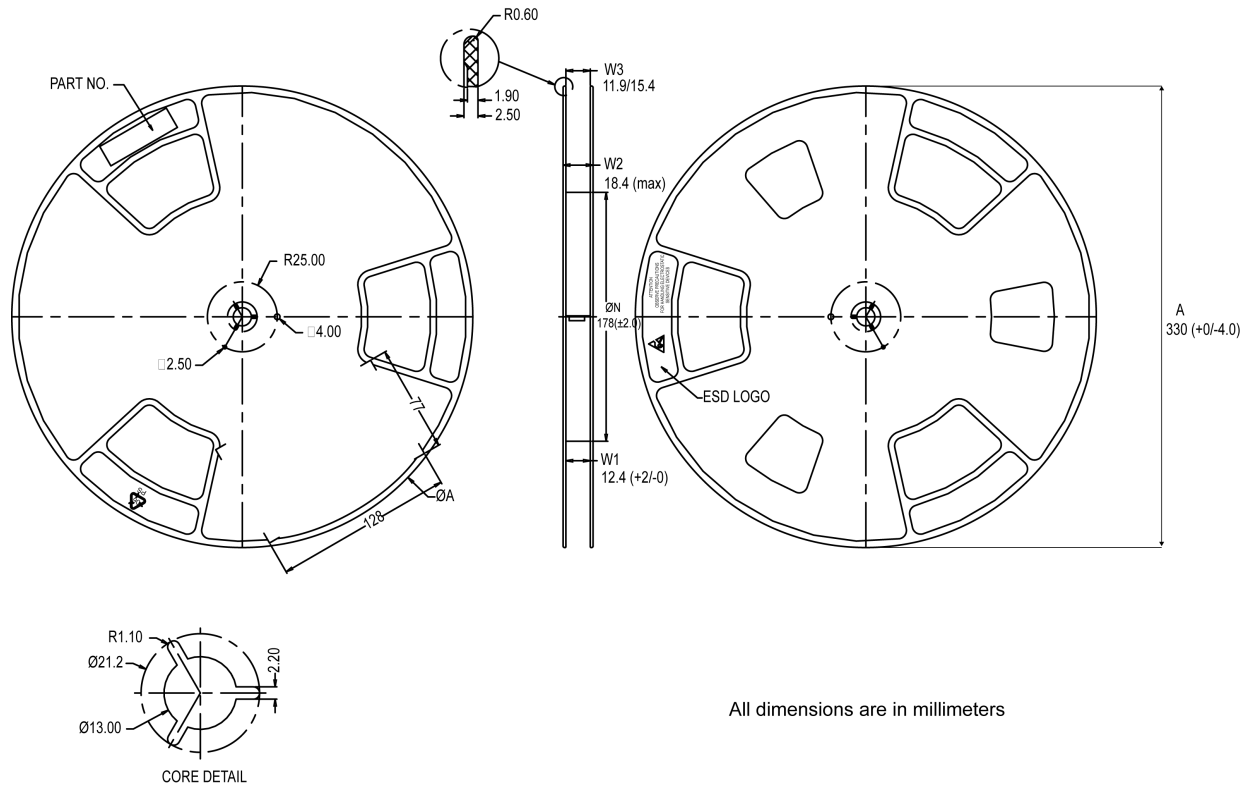


Figure 20. PowerFLAT 5x6 reel



All dimensions are in millimeters

8234350_Reel_rev_C

Revision history

Table 9. Document revision history

Date	Revision	Changes
28-Oct-2013	1	First release.
25-Aug-2014	2	Modified: <i>Figure 1: "Internal schematic diagram"</i> Updated: <i>Section 10: "Package mechanical data"</i> Minor text changes
24-Feb-2015	3	In title description on cover page, changed 0.02 Ω to 0.023 Ω In features table on cover page, changed 0.028 Ω to 0.026 Ω Updated <i>Table 2: Absolute maximum ratings</i> Updated <i>Table 4: Static</i> – renamed table and updated Static drain-source on-resistance values Updated <i>Table 5: Dynamic</i> – test conditions and all typical values Updated <i>Table 6: Switching times</i> – test conditions and all typical values Updated <i>Table 7: Source-drain diode</i> – test conditions and all typical values Added <i>Section 2.2: Electrical characteristics (curves)</i> Updated <i>Section 4: Package mechanical data</i> Minor text changes
15-Nov-2016	4	Updated title, features table and description on cover page Updated <i>Table 2: "Absolute maximum ratings"</i> Updated <i>Table 4: "Static", Table 5: "Dynamic", Table 6: "Switchingtimes" and Table 7: "Source drain diode"</i> Updated <i>Figure 9: "Normalized on-resistance vs. temperature"</i> Updated <i>Section 4.1: "PowerFLAT™ 5x6 type R package information"</i> Minor text changes
19-Nov-2019	5	Added: <i>Section 4.1 PowerFLAT 5x6 type C SUBCON package information.</i> Minor text changes.

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